



## Insulation Materials for Energy Conservation in Buildings

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Deadline for manuscript  
submissions:

**closed (31 December 2021)**

### Message from the Guest Editor

This Special Issue covers several topics as outlined below:

1. advanced thermal insulation materials (including super insulation materials, vacuum insulations, aerogels);
2. natural-based and ecological thermal insulation materials;
3. utilization of insulation materials for rehabilitation of buildings;
4. Heat and moisture transport in structures of thermal insulation and other building materials;
5. utilization of waste and by-products in thermal insulation materials production; and
6. lifecycle and waste management of insulation materials and insulation systems.





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## Editor-in-Chief

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## Message from the Editor-in-Chief

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